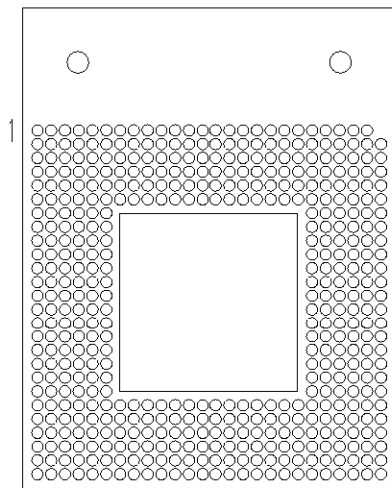
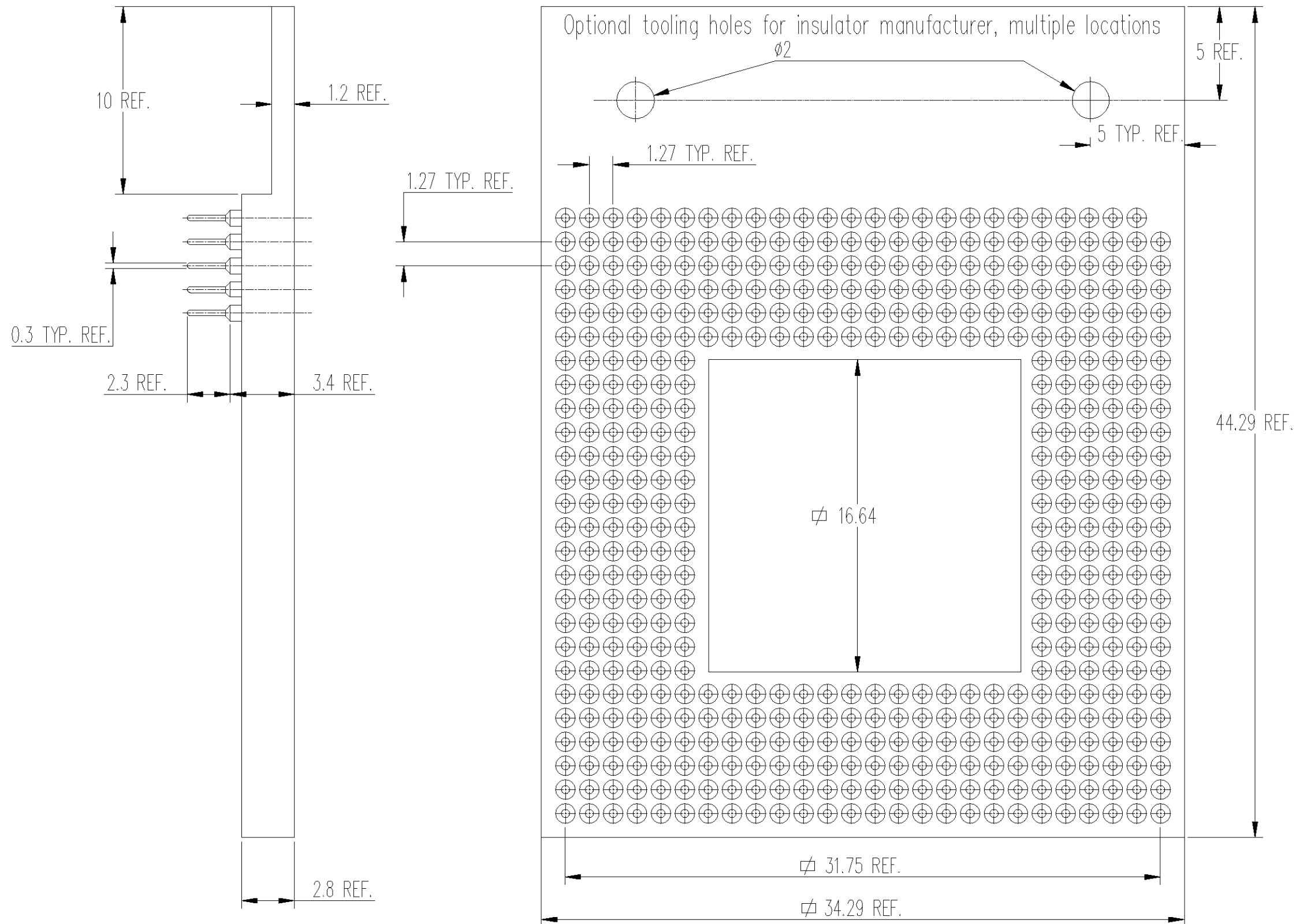


DRAWING NO
C - 799387



479 POSITIONS
SCALE 1:1



NOTE :

1. MATERIAL
 - INSULATOR : GLASSFILLED EPOXY FR-4
 - SOLDER TAIL SLEEVE : BRASS (799402-1)
 - CLIP : STAMPED BERYLLIUM COPPER
2. SLEEVE PLATING:
 - PREFIX "0-" : 5µm Sn/Pb OVER 2-3µm Ni
 - PREFIX "1-" : 0.25µm Au OVER 2-3µm Ni
 - PREFIX "2-" : 0.75µm Au OVER 2.3µm Ni
3. INNER CONTACT PLATING
 - SUFFIX "-1" 0.25µm 18c. Au
 - SUFFIX "-4" 0.75µm 24c. Au
4. INNER SPRING CONTACT ACCEPT Ø 0.30 TO 0.56 OR RECTANGULAR PIN 0.25 x 0.45

DIMENSIONS	mm	D	EW00-0132-01	E.BRESSOUD	13 SEP 01	H. CACHOD	DRAWN E. BRESSOUD	06 FEB 01	THIS INFORMATION IS CONFIDENTIAL AND IS DISCLOSED TO YOU ON CONDITION THAT NO FURTHER DISCLOSURE IS MADE BY YOU TO OTHER THAN AMP PERSONNEL WITHOUT WRITTEN AUTHORIZATION FROM DSM SWITZERLAND.			
		C	EW00-0089-01	E.BRESSOUD	12 JUN 01	G.GALEAZZI	CHECKED S. CHANDEVAVLT	06 FEB 01				
		B	EW00-0063-01	E.BRESSOUD	05 AVR 01	G.GALEAZZI	APPROVED G.GALEAZZI	07 FEB 01	NAME MICRO PIN GRID ARRAY IC SOCKET 1.27mm CENTERLINE, 479- 26/26			
SURFACE TEXTURE	N7 (✓)	A	EW00-0056-01	E.BRESSOUD	28 MAR 01		CUSTOMER DRAWING FOR REFERENCE ONLY					
PRODUCT SPEC.		P	REV	ECN	DRWN	DATE	APVD					
DSM DECOLLETAGE SA SAINT-MAURICE CH 1890 SAINT-MAURICE (VS)							LOC	SCALE	SIZE	DRAWING NO	SHEET	REVISION
WAS ESA N°704.479.26FH.x.x							EK	3/1	A4	C - 799387	1 of 1	D